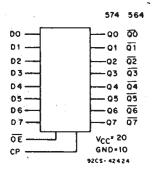
Data sheet acquired from Harris Semiconductor SCHS292



Octal D-Type Flip-Flop, 3-State Positive-Edge-Triggered

CD54/74AC/ACT564 - Inverting CD54/74AC/ACT574 - Non-Inverting

Type Features:

- Buffered inputs
- Typical propagation delay: 6.5 ns @ V_{CC} = 5 V, T_A = 25° C, C_L = 50 pF

FUNCTIONAL DIAGRAM

The RCA-CD54/74AC564 and CD54/74AC574 and the CD54/74ACT564 and CD54/74ACT574 octal D-type, 3-state, positive-edge-triggered flip-flops use the RCA ADVANCED CMOS technology. The eight flip-flops enter data into their registers on the LOW-to-HIGH transition of the clock (CP). The Output Enable (OE) controls the 3-state outputs and is independent of the register operation. When the Output Enable (OE) is HIGH, the outputs are in the high-impedance state. The CD54/74AC/ACT564 and CD54/74AC/ACT574 share the same pin configurations; the CD54/74AC/ACT564, however, has inverted outputs and the CD54/74AC/ACT574 has non-inverted outputs.

The CD74AC/ACT564 and CD74AC/ACT574 are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead dual-in-line small-outline plastic packages (M suffix). Both package types are operable over the following temperature ranges: Commercial (0 to 70°C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to +125°C).

The CD54AC/ACT564 and CD54AC/ACT574, available in chip form (H suffix), are operable over the -55 to +125°C temperature range.

Family Features:

- Exceeds 2-kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-resistant CMOS process and circuit design
- Speed of bipolar FAST*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
- ± 24-mA output drive current
 - Fanout to 15 FAST* ICs
 - Drives 50-ohm transmission lines

*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

TRUTH TABLE

| | INPUTS | OUT | PUTS | |
|----|--------|-----|------|----|
| | | 564 | 574 | |
| ŌĒ | СР | Dn | Qn | Qn |
| L | | Н | L | Н |
| L | | L | Н | L |
| L | L | Х | QΘ | QO |
| Н | Х | Х | Z | Z |

H = High level (steady state)

L = Low level (steady state)

X = Don't care

_/ = Transition from low to high level

QO = The level of Q before the indicated steady-state input conditions were established

QO = The level of Q before the indicated steady-state input conditions were established.

Z = High impedance

This data sheet is applicable to the CD54/74AC574 and CD54/74ACT574. The CD54/74AC564 and CD54/74ACT564 were not acquired from Harris Semiconductor.

| MAXIMUM RATINGS, Absolute-Maximum Values: | |
|---|-------------------------------------|
| DC SUPPLY-VOLTAGE (Vcc) | 0.5 to 6 V |
| DC INPUT DIODE CURRENT, I_{iK} (for $V_i < -0.5 \text{ V or } V_i > V_{CC} + 0.5 \text{ V}$) | ±20 mA |
| DC OUTPUT DIODE CURRENT, I_{OK} (for $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V) | ±50 mA |
| DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, to (for Vo > -0.5 V or Vo | |
| DC V _{CC} or GROUND CURRENT (I _{CC} or I _{GND}) | ±100 mÁ* |
| POWER DISSIPATION PER PACKAGE (PD): | |
| For T _A = -55 to +100°C (PACKAGE TYPE E) | |
| For T _A = +100 to +125°C (PACKAGE TYPE E) | |
| For $T_A = -55$ to $+70$ °C (PACKAGE TYPE M) | |
| For $T_A = +70$ to $+125^{\circ}$ C (PACKAGE TYPE M) | Derate Linearly at 6 mW/°C to 70 mW |
| OPERATING-TEMPERATURE RANGE (TA): | 55 to +125°C |
| STORAGE TEMPERATURE (T _{stg}) | 65 to +150°C |
| LEAD TEMPERATURE (DURING SOLDERING): | |
| At distance 1/16 \pm 1/32 in. (1.59 \pm 0.79 mm) from case for 10 s maximum | |
| Unit inserted into PC board min. thickness 1/16 in. (1.59 mm) with solder contacting | ng lead tips only +300°C |
| *For up to 4 outputs per device; add \pm 25 mA for each additional output. | |
| | |

RECOMMENDED OPERATING CONDITIONS:

For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

| | | LIMITS | | LINUTO |
|---|----------|--------|------|--------|
| CHARACTERISTIC | | MIN. | MAX. | UNITS |
| Supply-Voltage Range, Vcc*: | | | | |
| (For T _A = Full Package-Temperature Range) | | 4.5 | | |
| AC Types | | 1.5 | 5.5 | V |
| ACT Types | <u> </u> | 4.5 | 5.5 | V |
| DC Input or Output Voltage, V _I , Vo | | 0 | Vcc | V |
| Operating Temperature, Ta: | | -55 | +125 | °C |
| Input Rise and Fall Slew Rate, dt/dv | | | | |
| at 1.5 V to 3 V (AC Types) | | 0 | 50 | ns/V |
| at 3.6 V to 5.5 V (AC Types) | | 0 | 20 | ns/V |
| at 4.5 V to 5.5 V (ACT Types) | | 0 | 10 | ns/V |

^{*}Unless otherwise specified, all voltages are referenced to ground.

TERMINAL ASSIGNMENT DIAGRAMS



CD54/74AC/ACT564

CD54/74AC/ACT574

STATIC ELECTRICAL CHARACTERISTICS: AC Series

| , | | • | | | AMBIENT TEMPERATURE (TA) - °C | | | | | | |
|----------------------------------|-----------------|------------------------------|------------------------|-----|-------------------------------|------|----------|--------|-------|--------|----------|
| CHARACTERISTICS | | TEST CO | TEST CONDITIONS | | V _{cc} +25 | | -40 | to +85 | -55 t | o +125 | UNITS |
| | | . V, (V) | l _o (mA) | (V) | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| High-Level Input | | | | 1.5 | 1.2 | 1 – | 1.2 | _ | 1.2 | 1- | |
| Voltage | V _{IH} | | | 3 | 2.1 | - | 2.1 | _ | 2.1 | _ | 1 v |
| | | | | 5.5 | 3.85 | _ | 3.85 | _ | 3.85 | | 1 |
| Low-Level Input | | | | 1.5 | _ | 0.3 | _ | 0.3 | - | 0.3 | - |
| Voltage | VIL | | | 3 | _ | 0.9 | | 0.9 | _ | 0.9 | l v |
| | | | | 5.5 | | 1.65 | T - | 1.65 | _ | 1.65 | 1 |
| High-Level Output | | · · · · · · | -0.05 | 1.5 | 1.4 | T - | 1.4 | | 1.4 | | , |
| Voltage | V _{OH} | V _{IH} | -0.05 | 3 | 2.9 | | 2.9 | | 2.9 | T = | 1 |
| | • | or | -0.05 | 4.5 | 4.4 | | 4.4 | | 4.4 | T | 1 |
| | | V _{IL} | -4 | 3 | 2.58 | _ | 2.48 | _ | 2.4 | | l v |
| | - | | -24 | 4.5 | 3.94 | - | 3.8 | _ | 3.7 | | 1 |
| | | | -75 | 5.5 | | | 3.85 | | _ | _ | 1 |
| | | #. * { | -50 | 5.5 | _ | | <u> </u> | | 3.85 | _ | 1 |
| Low-Level Output | | | 0.05 | 1.5 | _ | 0.1 | | 0.1 | _ | 0.1 | |
| Voltage | Vol | V _{IH} | 0.05 | 3 | _ | 0.1 | _ | 0.1 | _ | 0.1 | |
| | | or | 0.05 | 4.5 | _ | 0.1 | _ | 0.1 | _ | 0.1 | v |
| | | V _{IL} | 12 | 3 | _ | 0.36 | _ | 0.44 | _ | 0.5 | |
| | | | 24 | 4.5 | _ | 0.36 | _ | 0.44 | _ | 0.5 | |
| | | | 75 | 5.5 | _ | _ | _ | 1.65 | _ | _ | |
| | | #, * { | 50 | 5.5 | | _ | <u> </u> | _ | _ | 1.65 | |
| Input Leakage Current | I _t | V _{cc} or GND | | 5.5 | - | ±0.1 | | ±1 | _ | ±1 | μΑ |
| 3-State Leakage | | ViH | | | | | | | | | |
| Current | loz | or | | | | | | | | | |
| | | VıL | | | | | | | | | |
| | | ' Vo = | | 5.5 | _ | ±0.5 | _ | ±5 | | ±10 | μΑ |
| | | Vcc | | | | | | | | ٠ . | • |
| | | or | | | | | | | | | |
| | | GND | | | | | | | | | |
| Quiescent Supply Current, MSI | Icc | V _{cc} or GND | 0 | 5.5 | | 8 | _ | 80 | | 160 | μΑ |

[#]Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
*Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

STATIC ELECTRICAL CHARACTERISTICS: ACT Series

| | | | | | AMBIEN | T TEMPE | RATURE | (T _A) - ° | С | J | |
|--|----------------------|--|--------------------------|------------------|----------|---------|-------------|-----------------------|---------|------|-------|
| CHARACTERISTICS | | TEST CO | NOITIONS V _{cc} | | + | 25 | -40 t | o +85 | -55 to | +125 | UNITS |
| | CHARACTERISTICS | | l _o (mA) | (V) | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | UNITS |
| High-Level Input Voltage | V _{IH} | | | 4.5 to 5.5 | 2 | _ | 2 | _ | 2 | _ | ٧ |
| Low-Level Input Voltage | Vil | | | 4.5 to 5.5 | _ | 0.8 | _ | 0.8 | | 0.8 | v |
| High-Level Output | | V _{IH} | -0.05 | 4.5 | 4.4 | | 4.4 | _ | 4.4 | | |
| Voltage | V _{OH} | or | -24 | 4.5 | 3.94 | | 3.8 | _ | 3.7 | _ | v |
| | | VII. | -75 | 5.5 | | | 3.85 | | _ | _ |] ` |
| | | #, * { | -50 | 5.5 | _ | _ | | _ | 3.85 | _ | 7 |
| Low-Level Output | | V _{IH} | 0.05 | 4.5 | | ±0.1 | | ±.1 | | ±.1 | |
| Voltage | Vol | or | 24 | 4.5 | | 0.36 | | 0.44 | | 0.5 | V |
| | | VIL S | 75 | 5.5 | _ | | | 1.65 | _ | _ |] |
| | | #, * { | 50 | 5.5 | | - | _ | _ | _ | 1.65 | |
| Input Leakage Current | l _i | V _{cc} or GND | | 5.5 | _ | ±0.1 | _ | ±1 | <u></u> | ±1 | μΑ |
| 3-State Leakage Current | loz | V _{IH} or V _{IL} | | | | | | | | | |
| | | V _o = V _{cc} or GND | | 5.5 | <u>-</u> | ±0.5 | | ±5 | | ±10 | μΑ |
| Quiescent Supply Current, MSI | lcc | V _{cc} or GND | 0 | 5.5 | | 8 | _ | 80 | | 160 | μΑ |
| Additional Quiescent Current per Input Pi TTL Inputs High 1 Unit Load | Supply in ΔIcc | V _{cc} -2.1 | | 4.5 to 5.5 | — | 2.4 | | 2.8 | _ | 3 | mA |

[#]Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.

ACT INPUT LOADING TABLE

| INPUT | UNIT LOADS* |
|-------|-------------|
| D, ŌĒ | 0.7 |
| CP | 1.17 |

^{*}Unit load is ΔI_{CC} limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

^{*}Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

PREREQUISITE FOR SWITCHING: AC Series

| | | | AMBI | ENT TEMP | ERATURE (| Γ _Λ) -°C | |
|-----------------------------|-----------------|------------------------|------------------|----------|-----------------|----------------------|-------|
| CHARACTERISTICS | SYMBOL | V _{cc} (V) | -40 to +85 | | -55 to +125 | | UNITS |
| <u> </u> | | . (¥) ∴ | MIN. | MAX. | MIN. | MAX. | 1 |
| Clock Pulse Width | tw | 1.5 3.3* 5† | 44 4.9 3.5 | _ | 50 5.6 4 | | ns |
| Setup Time Data to Clock | t _{su} | 1.5 3.3 5 | 2 2 2 | | 2 2 2 | | ns |
| Hold Time Data to Clock | ţ t H | 1.5 3.3 5 | 2 2 2 | = . | 2 2 2 | | ns |
| Maximum Clock Frequency | fmax | 1.5 3.3 5 | 11 101 143 | | 10 89 125 | | MHz |

*3.3 V: min. is @ 3 V †5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: AC Series; t_{rr} , t_{t} = 3 ns, C_{L} = 50 pF

| | | | AMB | ENT TEMP | ERATURE (| T _A) -°C | T |
|---|--------------------------------------|-------------------|---------------|---------------------|----------------|----------------------|-------|
| CHARACTERISTICS | SYMBOL | SYMBOL (V) | | -40 to +85 | | -55 to +125 | |
| | | (*) | MIN. | MAX. | MIN. | MAX. | UNITS |
| Propagation Delays: Clock to Q AC574 | tpLH tpHL | 1.5 3.3* 5† | _ 4 2.9 | 123 13.7 9.8 | 3.8 2.7 | 135 15.1 10.8 | ns |
| Clock to Q AC564 | t _{PLH} t _{PHL} | 1.5 3.3 5 | 4.1 2.9 | 128 14.4 10.3 | _ 4 2.8 | 141 15.8 11.3 | ns |
| Output Enable to Q, ቒ | t _{PZL} t _{PZH} | 1.5 3.3 5 | 5.6 3.7 | 165 19.2 13.2 | 5.5 3.6 | 181 21.8 14.5 | ns |
| Output Disable to Q, Q | t _{PLZ} t _{PHZ} | 1.5 3.3 5 | 4.7 3.7 | 165 16.5 13.2 | 4.5 3.6 | 181 18.1 14.5 | ns |
| Power Dissipation Capacitance | C _{PD} § | _ | 67 | Тур. | 67 | Гур. | pF |
| Min. (Valley) V _{OH} During Switching of Other Outputs (Output Under Test Not Switching) | V _{онv} See . Fig. 1 | 5 | 4 Typ. @ 25°C | | v | | |
| Max. (Peak) Vol. During Switching of Other Outputs (Output Under Test Not Switching) | V _{OLP} See Fig. 1 | 5 | 1 Typ. @ 25°C | | : | ٧ | |
| Input Capacitance | Cı | | | 10 | _ | 10 | pF |
| 3-State Output Capacitance | Co | | _ | 15 | | 15 | pF |

*3.3 V: min. is @ 3.6 V max. is @ 3 V †5 V: min. is @ 5.5 V max. is @ 4.5 V

§C_{PD} is used to determine the dynamic power consumption, per flip flop.

 $P_D = C_{PO} V_{CC}^2 f_i + \sum V_{CC}^2 f_O C_L$ where $f_i = input$ frequency

fo = output frequency C_L = output load capacitance

V_{cc} = supply voltage.

Technical Data

CD54/74AC564, CD54/74AC574 CD54/74ACT564, CD54/74ACT574

PREREQUISITE FOR SWITCHING: ACT Series

| | | AMBIEN | | ENT TEMPE | NT TEMPERATURE (TA) -°C | | | |
|-----------------------------|-----------------|------------------------|----------------------------|-----------|-------------------------|------|-------|--|
| CHARACTERISTICS | SYMBOL | V _{cc} (V) | V _{cc} -40 to +85 | | -55 to +125 | | UNITS | |
| | | (4) | MIN. | MAX. | MIN. | MAX. | | |
| Clock Pulse Width | tw | 5† | 3.9 | _ | 4.5 | _ | ns | |
| Setup Time Data to Clock | t _{su} | 5 | 2 | <u> </u> | 2 | _ | ns | |
| Hold Time Data to Clock | t _H | 5 | 2.6 | | 3 | _ | ns | |
| Maximum Clock Frequency | fmax | 5 | 125 | | 110 | | MHz | |

†5 V: min. is @ 4.5 V

SWITCHING CHARACTERISTICS: ACT Series; t,, t, = 3 ns, CL = 50 pF

| | | | AMBI | | | | |
|---|--------------------------------------|-----------------|---------------|--------|-------------|------|-------|
| CHARACTERISTICS | SYMBOL | V _{cc} | -40 to +85 | | -55 to +125 | | UNITS |
| OTATIA TETRO TO | | (V) | MIN. | MAX. | MIN. | MAX. | |
| Propagation Delays: Clock to Q ACT574 | tецн tень | 5† | 2.9 | 10.2 | 2.8 | 11.2 | ns |
| Clock to Q ACT564 | t _{PLH} t _{PHL} | 5 | 3 | 10.6 | 2.9 | 11.7 | ns |
| Output Enable and Disable to Q ACT574 | tplz tpHz tpZL tpZH | 5 | 3.7 | 13.2 | 3.6 | 14.5 | ns |
| Output Enable and Disable to Q ACT564 | tplz tpHz tpzl tpzH | 5 | 3.7 | 13.2 | 3.6 | 14.5 | ns |
| Power Dissipation Capacitance | C _{PO} § | | 67 | Тур | 67 | Тур. | pF |
| Min. (Valley) V _{он} During Switching of Other Outputs (Output Under Test Not Switching) | V _{онv} See Fig. 1 | 5 | 4 Typ. @ 25°C | | V | | |
| Max. (Peak) V _{OL} During Switching of Other Outputs (Output Under Test Not Switching) | V _{OLP} See Fig. 1 | 5 | | 1 Typ. | @ 25°C | | V |
| Input Capacitance | Cı | | | 10 | | 10 | ρF |
| 3-State Output Capacitance | Co | _ | | 15 | | 15 | pF |

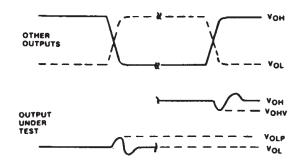
†5 V: min. is @ 5.5 V max. is @ 4.5 V

 $\S{C_{PD}}$ is used to determine the dynamic power consumption, per flip flop. $P_D = C_{PD} \ V_{CC}^2 \ f_i + \Sigma \ V_{CC}^2 \ f_0 \ C_L + V_{CC} \ \Delta I_{CC}$ where $f_i =$ input frequency

 f_0 = output frequency C_L = output load capacitance

 $V_{cc} = supply voltage.$

PARAMETER MEASUREMENT INFORMATION



- VOHY AND VOLP ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST.
 INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:
- PRR \leq 1 MHz, $t_{\rm f}$ = 3 ns, $t_{\rm f}$ = 3 ns, SKEW 1 ns.
- 3. R.F. FIXTURE WITH 700-MHz DESIGN RULES REQUIRED.
 IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASSED WITH 0.1 µF CAPACITOR. SCOPE AND PROBES REQUIRE 700-MH2 BANDWIDTH.

9205-42406

Fig. 1 - Simultaneous switching transient waveforms.

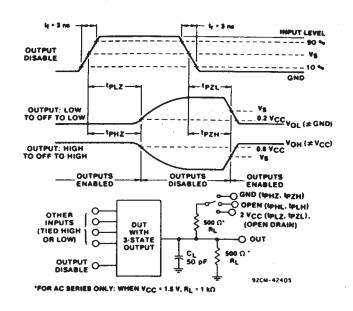
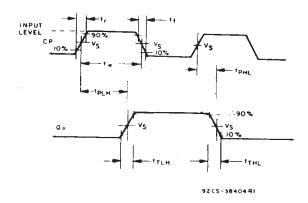
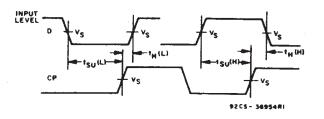
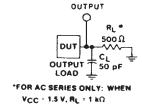


Fig. 2 - Three-state propagation delay waveforms and test circuit.







| | CD54/74AC | CD54/74ACT |
|------------------------------|---------------------|---------------------|
| Input Level | V _{cc} | 3 V |
| Input Switching Voltage, Vs | 0.5 V _{CC} | 1.5 V |
| Output Switching Voltage, Vs | 0.5 V _{cc} | 0.5 V _{CC} |

Fig. 3 - Propagation delays times and test circuit.

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